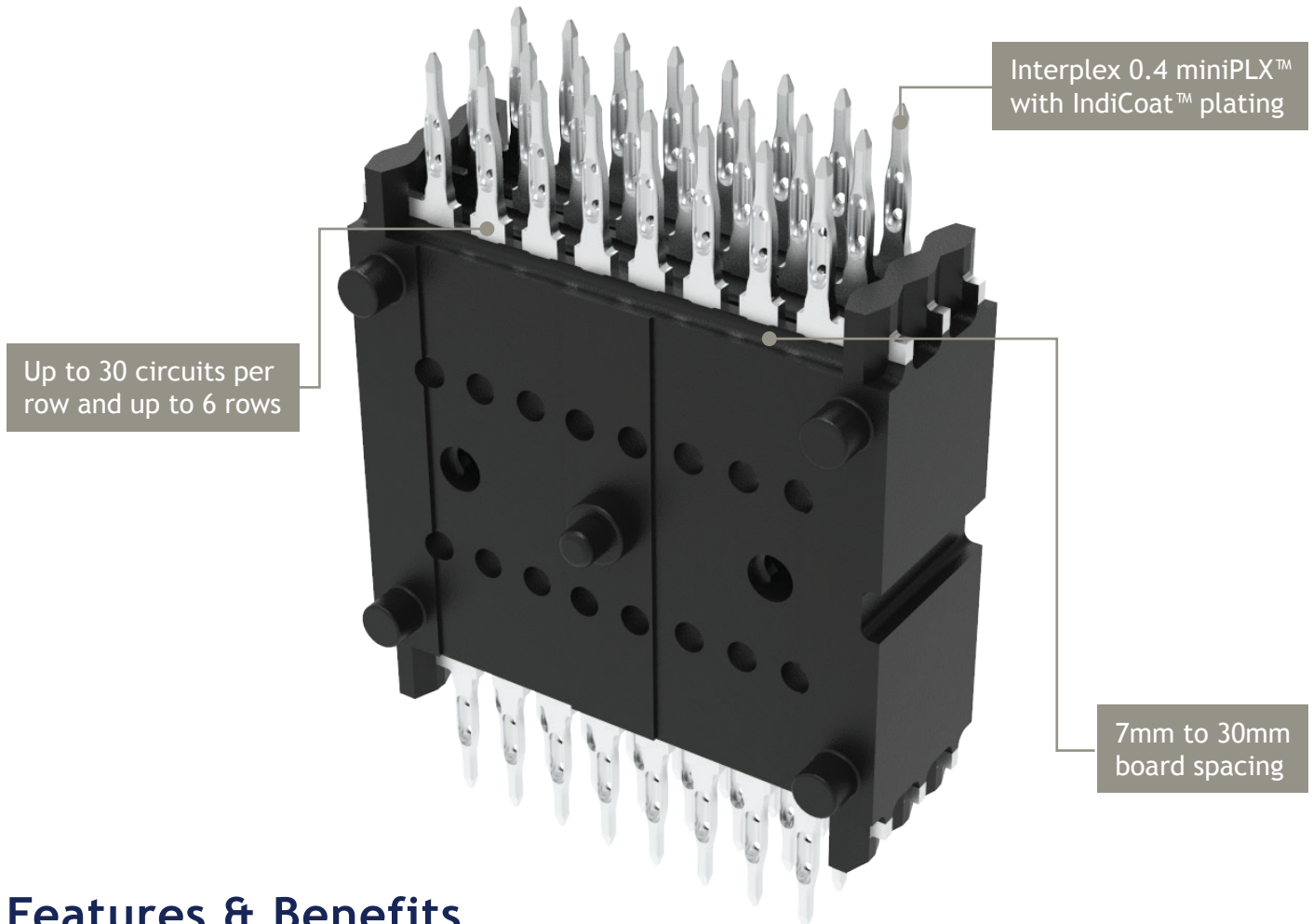


Multi-Row Board-to-Board Connector



Features & Benefits

- Pluggable, repeatable, reliable and Automotive-approved Press-Fit solution
- 0.4 miniPLX™ Press-Fin pins with IndiCoat™, a whisker mitigation plating technology developed by Interplex
- High density - 1.8 x 2.0mm grid
- Robust design
- High circuit size & board height flexibility

Applications

- Sensors & Actuators
- Control Units

Industries



Automotive



Medical & Life Sciences



Industrial



Transportation

